IPC ASSOCIATION ELECTRONIC	© Copyright 2005	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under international and Pan-American copyright conventions.			nder both le	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					eous Materia	ials and Mfg Information			
upplie	r Information						·								
Company name* Company unique ID				nique ID	Unique ID Authority			ority Res			Response	esponse Date*			
nsemi												2025-07-12			
Contact N	lame	Title - Contact			I	Phone - Contact*					Email - Contact*				
?roduct-I	Env-Stewards		Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com				
uthorize	ed Representative*	Title - Representative			I	Phone - Representative*				Email - Representative*					
Product-I	Env-Stewards	Product Env	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Ite		m Number Mfr Item Name				Effective Date	ate Version Manufacturing Site		ring Site	W	eight*	UOM	Unit Type	
		FUSB25	251UCX USB Type-C High Volta Moisture Detection		Voltage Protect	with	2025-07-12		I	PBB		3.	58693	mg	Each
Ianufa	cturing Process Inform	ation													
	Terminal Plating / Grid Array I	Terminal Base Alloy J-STD-020 MSI		-STD-020 MSL	Rating	Peak Process Body Temperature Max Time at Pe		ime at Peak	Temperatu	re Numb	er of Reflow Cyc	eles			
SnAgCu		CU Alloy 1				260	260 C 30			seconds 3					
mments	8														
vel 1 - m	naximum time at peak tempera	ture during so	ldering is 10	30 seconds											
or more	information regarding materi	al composition	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	ceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Backside Protection Film	0.13045	mg		Epoxy resin	proprietary data		0.0273	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0024	mg
			Supplier	Acrylic resins	Proprietary Data		0.0273	mg
			Supplier	Silica (SiO2)	14464-46-1		0.0734	mg
Die	2.54293	mg	Supplier	Silicon (Si)	7440-21-3		2.5353	mg
			Supplier	Aluminum (Al)	7429-90-5		0.0076	mg
Solder Ball	0.912573	mg	Supplier	Silver (Ag)	7440-22-4		0.0365	mg
			Supplier	Tin (Sn)	7440-31-5		0.8715	mg
			Supplier	Copper (Cu)	7440-50-8		0.0046	mg
Under Bump Metal	9.77E-4	mg	Supplier	Titanium (Ti)	7440-32-6		0.0002	mg
			Supplier	Copper (Cu)	7440-50-8		0.0007	mg